

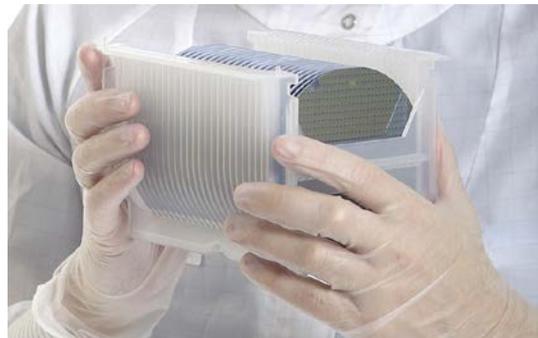
For immediate release

Release Contact:
Bob Sheeran
bsheeran@technic.com
401-785-8763

Technic to present on selective removal of post-etch residues at UCPSS Bi-Annual Symposium

Cranston, RI, USA – Technic will be presenting a technical paper *Customized Chemical Compositions Adaptable for Cleaning Virtually All Post-Etch Residues* at the bi-annual **UCPSS Symposium** in Leuven, Belgium September 2-5, 2018.

The paper is a collaboration between Technic, STMicroelectronics, and CEA-Leti and will be presented by Technic's Technology and Innovation Director, Dr. Jerome Daviot. The presentation will focus on an optimized cleaning solution to meet the challenges of post-etch residue removal of high-k materials such as tantalum, zirconium, and hafnium which are notoriously resilient and difficult to remove.



About the Symposium

The UCPSS (Ultra Clean Processing of Semiconductor Surfaces) symposium is a bi-annual event devoted to cleaning and surface preparation for micro and nano-technology in electronic applications and related fields such as photovoltaics and bio-electronics.

It is the purpose of the UCPSS symposium to increase the level of understanding on ultra-clean processing and surface preparation in all steps of the fabrication of ICs, PV-modules and bioelectronics devices. The conference consists of invited presentations, as well as selected contributing presentations and posters.

To learn more about **UCPSS2018**, go to <http://www.ucpss.org>

About Technic

Technic Inc. is a Rhode Island based corporation with over 900 employees worldwide. For over 73 years, Technic has been a global supplier of specialty chemicals, custom finishing equipment, engineered powders, and analytical control systems to the semiconductor, electronic component, printed circuit board, industrial finishing and decorative industries. Technic is also a major supplier of engineered metal powders to the solar industry.